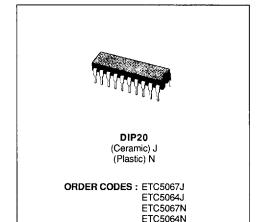


T-75-11-09 ETC5067 ETC5064

NOZMOHT-Z & Z

SERIAL INTERFACE CODEC/FILTER WITH RECEIVE POWER AMPLIFIER

- COMPLETE CODEC AND FILTERING SYSTEM INCLUDING:
 - Transmit high-pass and low-pass filtering
 - Receive low-pass filter with sin x/x correction
 - Active RC noise filters
 - μ-law or A-law compatible COder and DECoder
 - Internal precision voltage reference
 - Serial I/O interface
 - Internal auto-zero circuitry
 - Receive push-pull power amplifiers
- μ -LAW ETC5064
- A-LAW ETC5067
- MEETS OR EXCEEDS ALL D3/D4 AND CCITT SPECIFICATIONS
- ± 5 V OPERATION
- LOW OPERATING POWER TYPICALLY 70 mW
- POWER-DOWN STANDBY MODE TYPI-CALLY 3 mW
- AUTOMATIC POWER-DOWN
- TTL OR CMOS COMPATIBLE DIGITAL INTER-FACES
- MAXIMIZES LINE INTERFACE CARD CIRCUIT DENSITY



DESCRIPTION The ETC5064 (μ-law) and ETC5067 (A-law) are monolithic PCM CODEC/FILTERS utilizing the A/D and D/A conversion architecture shown in figure 1,

and a serial PCM interface.
The devices are fabricated using double poly CMOS process.

Similar to the ETC505X family, these devices feature an additional Receive Power Amplifier to provide push-pull balanced output drive capability. The receive gain can be adjusted by means of two external resistors for an output level of up to $\pm~6.6~V$ across a balanced $600~\Omega$ load.

Also included is an Analog Loopback switch and $\overline{TS}_{\overline{X}}$ output.

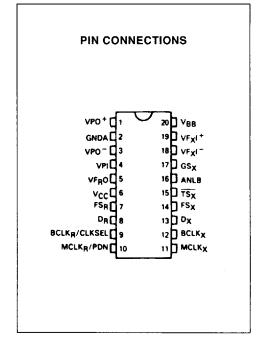
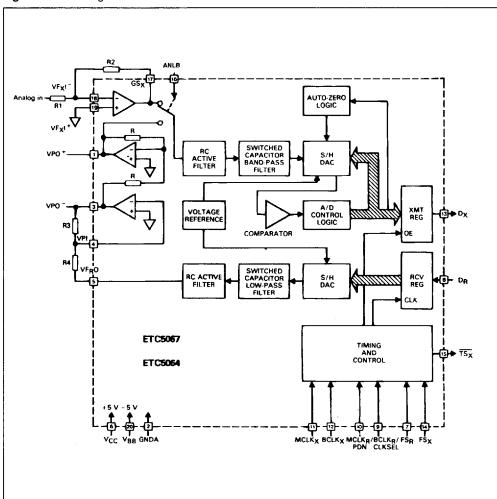


Figure 1 : Block Diagram.

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PIN DESCRIPTION

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| Name | Pin Type* | N° | Description |
|--------------------------------|--------------|----|--|
| VPO + | 0 | 1 | The Non-inverting Output of the Receive Power Amplifier |
| GNDA | GND | 2 | Analog Ground. All signals are referenced to this pin. |
| VPO - | 0 | 3 | The Inverting Output of the Receive Power Amplifier |
| VPI | ı | 4 | Inverting Input to the Receive Power Amplifier. Also powers down both amplifiers when connected to V_{BB} . |
| VF _R O | 0 | 5 | Analog Output of the Receive Filter. |
| V _{CC} | S | 6 | Positive Power Supply Pin. V _{CC} = + 5 V ± 5 % |
| FS _R | l | 7 | Receive Frame Sync Pulse which enable BCLK $_{\rm R}$ to shift PCM data into D $_{\rm R}$. FS $_{\rm R}$ is an 8 kHz pulse train. See figures 2 and 3 for timing details. |
| D _R | _ | 8 | Receive Data Input. PCM data is shifted into D _R following the FS _R leading edge. |
| BCLK _B /CLKSEL | _ | 9 | The bit Clock which shifts data into D_R after the FS $_R$ leading edge. May vary from 64 kHz to 2.048 MHz. Alternatively, may be a logic input which selects either 1.536 MHz/1.544 MHz or 2.048 MHz for master clock in synchronous mode and BCLK $_X$ is used for both transmit and receive directions (see table 1). This input has an internal pull-up. |
| MCLK _R /PDN | I | 10 | Receive Master Clock. Must be 1.536 MHz, 1.544 MHz or 2.048 MHz. May be asynchronous with MCLK $_{\rm X}$, but should be synchronous with MCLK $_{\rm X}$ for best performance. When MCLK $_{\rm R}$ is connected continuously low, MCLK $_{\rm X}$ is selected for all internal timing. When MCLK $_{\rm R}$ is connected continuously high, the device is powered down. |
| MCLK _X | I | 11 | Transmit Master Clock. Must be 1.536 MHz, 1.544 MHz or 2.048 MHz. May be asynchronous with MCLK _R . |
| BCLK _X | I | 12 | The bit clock which shifts out the PCM data on D _x . May vary from 64 kHz to 2.048 MHz, but must be synchronous with MCLK _x . |
| D _X | 0 | 13 | The TRI-STATE® PCM data output which is enabled by FS _X . |
| FS _X | I | 14 | Transmit frame sync pulse input which enables $BCLK_X$ to shift out the PCM data on D_X . FS_X is an 8 kHz pulse train. See figures 2 and 3 for timing details. |
| TS _X | 0 | 15 | Open drain output which pulses low during the encoder time slot. Must to be grounded if not used. |
| ANLB | 1 | 16 | Analog Loopback Control Input. Must be set to logic 'O' for normal operation. When pulled to logic '1', the transmit filter input is disconnected from the output of the transmit preamplifier and connected to the VPO * output of the receive power amplifier. The input has an internal* pull down. |
| GS _X | 0 | 17 | Analog output of the transmit input amplifier. Used to set gain externally. |
| VF _X I - | 1 | 18 | Inverting input of the transmit input amplifier. |
| VF _X I ⁺ | 1 | 19 | Non-inverting input of the transmit input amplifier. |
| V _{BB} | S | 20 | Negative Power Supply Pin. V _{BB} = - 5 V ± 5 % |

^{1 :} Input, O : Output, S : Power Supply.

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FUNCTIONAL DESCRIPTION

POWER-UP

When power is first applied, power-on reset circuitry initializes the COMBO and places it into the powerdown mode. All non-essential circuits are deactivated and the Dx and VFRO outputs are put in high impedance states. To power-up the device, a logical low level or clock must be applied to the MCLKR/PDN pin and FSx and/or FSR pulses must be present. Thus, 2 power-down control modes are available. The first is to pull the MCLKR/PDN pin high; the alternative is to hold both FSx and FSR inputs continuously low. The device will power-down approximately 2 ms after the last FSx or FSR pulse. Power-up will occur on the first FSx or FSR pulse. The TRI-STATE PCM data output, Dx, will remain in the high impedance state until the second FSx pulse.

SYNCHRONOUS OPERATION

For synchronous operation, the same master clock and bit clock should be used for both the transmit and receive directions. In this mode, a clock must be applied to MCLKx and the MCLKR/PDN pin can be used as a power-down control. A low level on MCLKR/PDN powers up the device and a high level powers down the device. In either case, MCLKx will be selected as the master clock for both the transmit and receive circuits. A bit clock must also be applied to BCLKx and the BCLKR/CLKSEL can be used to select the proper internal divider for a master clock of 1.536 MHz, 1.544 MHz or 2.048 MHz. For 1.544 MHz operation, the device automatically compensates for the 193 rd clock pulse each frame.

With a fixed level on the BCLK_R/CLKSEL pin, BCLK_X will be selected as the bit clock for both the transmit and receive directions. Table 1 indicates the frequencies of operation which can be selected, depending on the state of BCLK_R/CLKSEL. In this synchronous mode, the bit clock, BCLK_X, may be from 64 KHz to 2.048 MHz, but must be synchronous with MCLK_X.

Table 1: Selection of Master Clock Frequencies.

| BCLK _R /CLKSEL | Master Clock Frequency Selected | | | | |
|---------------------------|------------------------------------|---------------------------|--|--|--|
| DOLKHIOLKSEL | ETC 5067 | ETC 5064 | | | |
| Clocked . | 2.048 MHz | 1.536 MHz or 1.544 MHz | | | |
| 0 | 1.536 MHz or 1.544 MHz | 2.048 MHz | | | |
| 1 (or open circuit) | 2.048 MHz | 1.536 MHz or 1.544 MHz | | | |

Each FS $_X$ pulse begins the encoding cycle and the PCM data from the previous encode cycle is shifted out of the enabled D $_X$ output on the positive edge of BCLK $_X$. After 8 bit clock periods, the TRI-STATE D $_X$ output is returned to a high impedance state. With an FS $_R$ pulse, PCM data is latched via the D $_R$ input on the negative edge of BCLK $_X$ (or BCLK $_R$ if running). FS $_X$ and FS $_R$ must be synchronous with MCLK $_X$ ($_R$).

ASYNCHRONOUS OPERATION

For asynchronous operation, separate transmit and receive clocks may be applied. MCLKx and MCLKR must be 2.048 MHz for the ETC5067, or 1.536 MHz 1.544 MHz for the ETC5064, and need not be synchronous. For best transmission performance, however, MCLK_R should be synchronous with MCLK_X, which is easily achieved by applying only static logic levels to the MCLK_P/PDN pin. This will automatically connect MCLKx to all internal MCLKR functions (see Pin Description). For 1.544 MHz operation, the device automatically compensates for the 193 rd clock pulse each frame. FSx starts each encoding cycle and must be synchronous with MCLKx and BCLKx. FSR starts each decoding cycle and must be synchronous with BCLKR. BCLKR must be a clock, the logic levels shown in Table 1 are not valid in asynchronous mode. BCLKx and BCLKR may operate from 64 KHz to 2.048 MHz.

SHORT FRAME SYNC OPERATION

The COMBO can utilize either a short frame sync pulse or a long frame sync pulse. Upon power initialization, the device assumes a short frame mode. In this mode, both frame sync pulses, FSx and FSR. must be one bit clock period long, with timing relationships specified in figure 3. With FSx high during a falling edge of BCLKx, the next rising edge of BCLKx enables the Dx TRI-STATE output buffer, which will output the sign bit. The following seven rising edges clock out the remaining seven bits, and the next falling edge disables the Dx output. With FS_R high during a falling edge of BCLK_R (BCLK_X in synchronous mode), the next falling edge of BCLKR latches in the sign bit. The following seven falling edges latch in the seven remaining bits. Both devices may utilize the short frame sync pulse in synchronous or asynchronous operating mode.

LONG FRAME SYNC OPERATION

To use the long frame mode, both the frame sync pulses, FSx and FSn, must be three or more bit clock periods long, with timing relationships specified in figure 4. Based on the transmit frame sync. FSx, the

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COMBO will sense whether short or long frame sync pulses are being used. For 64 KHz operation, the frame sync pulses must be kept low for a minimum of 160 ns (see fig. 2). The Dx TRI-STATE output buffer is enabled with the rising edge of FSx or the rising edge of BCLKx, whichever comes later, and the first bit clocked out is the sign bit. The following seven BCLKx rising edges clock out the remaining seven bits. The Dx output is disabled by the falling BCLKx edge following the eight rising edge, or by FSx going low, whichever comes later. A rising edge on the receive frame sync pulse, FSR, will cause the PCM data at DR to be latched in on the next eight falling edges of BCLKR (BCLKx in synchronous mode). Both devices may utilize the long frame sync pulse in synchronous or asynchronous mode.

TRANSMIT SECTION

The transmit section input is an operational amplifier with provision for gain adjustment using two external resistors, see figure 5. The low noise and wide band-width allow gains in excess of 20 dB across the audio passband to be realized. The op amp drives a unity gain filter consisting of RC active prefilter, followed by an eighth order switched-capacitor bandpass filter clocked at 256 KHz. The output of this filter directly drives the encoder sample-andhold circuit. The A/D is of companding type according to A-law (ETC5067) or μ-law (ETC5064) coding conventions. A precision voltage reference is trimmed in manufacturing to provide an input overload (tmax) of nominally 2.5 V peak (see table of Transmission Characteristics). The FS_X frame sync pulse controls the sampling of the filter output, and then the successive-approximation encoding cycle begins. The 8-bit code is then loaded into a buffer and shifted out through Dx at the next FSx pulse. The total encoding delay will be approximately 165 µs (due to the transmit filter) plus 125 µs (due to encoding delay), which totals 290 us. Any offset voltage due to the filters or comparator is cancelled by sign bit integration.

RECEIVE SECTION

The receive section consists of an expanding DAC which drives a fifth order switched-capacitor low pass filter clocked at 256 kHz. The decoder is A-law (ETC5067) or μ-law (ETC5064) and the 5 th order low pass filter corrects for the sin x/x attenuation due to the 8 kHz sample and hold. The filter is then followed by a 2 nd order RC active post-filter and power amplifier capable of driving a 600 Ω load to a level of 7.2 dBm. The receive section is unity-gain. Upon the occurence of FSR, the data at the DR input is clocked in on the falling edge of the next eight BCLK_R (BCLK_X) periods. At the end of the decoder time slot, the decoding cycle begins, and 10 us later the decoder DAC output is updated. The total decoder delay is ~ 10 µs (decoder update) plus 110 µs (filter delay) plus 62.5 µs (1/2 frame), which gives approximately 180 us.

RECEIVE POWER AMPLIFIERS

Two inverting mode power amplifiers are provided for directly driving a matched line interface tranformer. The gain of the first power amplifier can be adjusted to boost the \pm 2.5 V peak output signal from the receive filter up \pm 3.3 V peak into an unbalanced 300 Ω load, or 4.0 V into an unbalanced 15 k load. The second power amplifier is internally connected in unity-gain inverting mode to give 6 dB of signal gain for balanced loads.

Maximum power transfer to a 600 Ω subscriber line termination is obtained by differentially driving a balanced transformer with a $\sqrt{2}$: 1 turns ratio, as shown in figure 5. A total peak power of 15.6 dBm can be delivered to the load plus termination.

Both power amplifiers can be powered down independently from the PDN input by connecting the VPI input to V_{BB}, saving approximately 12 mW of power.

ABSOLUTE MAXIMUM RATINGS

| Symbol | Parameter | Value | Unit |
|-------------------|--|--|------|
| Vcc | V _{CC} to GNDA | 7 | ٧ |
| V_{BB} | V _{BB} to GNDA | - 7 | V |
| $V_{IN.} V_{OUT}$ | Voltage at Any Analog Input or Output | V _{CC} + 0.3 to V _{BB} - 0.3 | ٧ |
| | Voltage at Any Digital Input or Output | V _{CC} + 0.3 to GNDA - 0.3 | V |
| Toper | Operating Temperature Range | - 25 to + 125 | °C |
| T _{stg} | Storage Temeperature Range | - 65 to + 150 | °C |
| | Lead Temperature (soldering, 10 seconds) | 300 | °C |

ELECTRICAL OPERATING CHARACTERISTICS

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 $V_{CC} = 5.0 \text{ V} \pm 5 \text{ \%}, V_{BB} = -5 \text{ V} \pm 5 \text{ \%}, \text{ GNDA} = 0 \text{ V}, T_{A} = 0 \text{ °C to 70 °C (unless otherwise noted)}; \text{ Typical characteristics specified at V}_{CC} = 5.0 \text{ V}, V_{BB} = -5.0 \text{ V}, T_{A} = 25 \text{ °C}; \text{ all signals are referenced to GNDA}.}$

DIGITAL INTERFACE

| Symbol | Parameter | | Min. | Тур. | Max. | Unit |
|-----------------|--|-----------------------------------|--------|--------|------------|------|
| VIL | Input Low Voltage | | _ | _ | 0.6 | ٧ |
| V _{IH} | Input High Voltage | | 2.2 | _ | - | ٧ |
| V _{OL} | Output Low Voltage $ \begin{array}{l} I_L = 3.2 \text{ mA} \\ I_L = 3.2 \text{ mA}, \end{array} $ Open Drain | D _X TS _X | _ _ | _ _ | 0.4 0.4 | ٧ |
| V _{OH} | Output High Voltage I _H = - 3.2 mA | D _X | 2.4 | _ | _ | ٧ |
| lιc | Input Low Current (GNDA $\leq V_{IN} \leq V_{IL}$, all digital inputs, except BCLK _B) | | 10 | _ | 10 | μА |
| I _{tH} | Input High Current (V _{IH} ≤ V _{IN} ≤ V _{CC}) except ANLB | | - 10 | _ | 10 | μА |
| loz | Output Current in High Impedance State (TRI–STATE) (GNDA \leq V ₀ \leq V _{CC}) | D _X | - 10 | _ | 10 | μА |

ANALOG INTERFACE WITH TRANSMIT INPUT AMPLIFIER (all devices)

| Symbol | Parameter | | Min. | Тур. | Max. | Unit |
|--------------------|--|--|-------|------|------|------|
| IıXA | Input Leakage Current (- 2.5 V ≤ V ≤ + 2.5 V) | VF _X I + or VF _X I - | - 200 | - | 200 | nA |
| R _I XA | Input Resistance (- 2.5 ≤ V ≤ + 2.5 V) | VF _X I ⁺ or VF _X I ⁻ | 10 | ı | _ | MΩ |
| RoXA | Output Resistance (closed loop, unity gain) | | - | 1 | 3 | Ω |
| RLXA | Load Resistance | GS _X | 10 | - | _ | kΩ |
| CLXA | Load Capacitance | GS _X | - | _ | 50 | pF |
| VoXA | Output Dynamic Range (R _L ≥ 10 kΩ) | GS _X | ± 2.8 | _ | _ | ٧ |
| A _V XA | Voltage Gain (VF _x I + to GS _x) | | 5000 | - | _ | V/V |
| FuXA | Unity Gain Bandwidth | | 1 | 2 | - | MHz |
| VosXA | Offset Voltage | | - 20 | - | 20 | mV |
| V _{CM} XA | Common-mode Voltage | | - 2.5 | _ | 2.5 | ٧ |
| CMRRXA | Common-mode Rejection Ratio | | 60 | - | - | dB |
| PSRRXA | Power Supply Rejection Ratio | | 60 | _ | _ | dB |

ANALOG INTERFACE WITH RECEIVE FILTER (all devices)

| Symbol | Parameter | | Min. | Тур. | Max. | Unit |
|--------|---|-------------------|-------|------|------|------|
| RoRF | Output Resistance | VF _R O | - | 1 | 3 | Ω |
| RLRF | Load Resistance (VF _R O + ± 2.5 V) | | 10 | - | _ | kΩ |
| CLRF | Load Capacitance | | - | _ | 25 | pF |
| VOSRO | Output DC Offset Voltage | | - 200 | _ | 200 | mV |

ELECTRICAL OPERATING CHARACTERISTICS (continued)

ANALOG INTERFACE WITH POWER AMPLIFIERS (all devices)

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| Symbol | Parameter | Min. | Тур. | Max. | Unit |
|-------------------|---|-------------|-------------|--------------------|------|
| IPI | Input Leakage Current (- 1.0 V ≤ VPI ≤ 1.0 V) | - 100 | _ | 100 | nA |
| RIPI | Input Resistance (- 1.0 V ≤ VPI ≤ 1.0 V) | 10 | - | _ | MΩ |
| VIOS | Input Offset vOltage | - 25 | _ | - 25 | m۷ |
| ROP | Output Resistance (inverting unity-gain at VPO + or VPO -) | _ | 1 | _ | Ω |
| Fc | Unity-gain Bandwidth, Open Loop (VPO -) | _ | 400 | - | kHz |
| C _L P | Load Capacitance (VPO $^+$ or VPO $^-$ to GNDA) $R_L \ge 1500~\Omega$ $R_L = 600~\Omega$ $R_L = 300~\Omega$ | - - - | - - - | 100 500 1000 | pF |
| GAp ⁺ | Gain VPO $^-$ to VPO $^+$ to GNDA, Level at VPO $^-$ = 1.77 Vrms (+ 3 dBm0) | - | - 1 | - | V/V |
| PSRR _P | Power Supply Rejection of V_{CC} or V_{BB} (VPO $^-$ connected to VPI) 0 kHz $-$ 4 kHz 0 kHz $-$ 50 kHz | 60 36 | - | - | dB |

POWER DISSIPATION (all devices)

| Symbol | Parameter | Min. | Тур. | Max. | Unit |
|-------------------|--------------------|------|------|------|------|
| I _{CC} 0 | Power-down Current | _ | 0.5 | 1.5 | mA |
| I _{BB} 0 | Power-down Current | _ | 0.05 | 0.3 | mA |
| lcc1 | Active Current | _ | 7.0 | 10.0 | mA |
| I _{BB} 1 | Active Current | _ | 7.0 | 10.0 | mA |

ALL TIMING SPECIFICATIONS

| Symbol | Parameter | | Min. | Тур. | Max. | Unit |
|-------------------|--|---|--------------|----------------|----------|------|
| 1/t _{PM} | Frequency of Master Clocks MCLK _X and MCLK _B Depends on the device used and the | | - | 1.536 2.048 | <u> </u> | MHz |
| | BCLK _R /CLKSEL pin. | | | 1.544 | - | |
| t _{wm} | Width of Master Clock High N | ICLK _X and MCLK _R | 160 | _ | - | ns |
| t _{WML} | Width of Master Clock Low M | ICLK _X and MCLK _R | 160 | _ | - | ns |
| t _{RM} | Rise Time of Master Clock M | ICLK _X and MCLK _R | _ | - | 50 | ns |
| t _{FM} | Fall Time of Master Clock M | ICLK _X and MCLK _R | _ | _ | 50 | ns |
| t _{PB} | Period of Bit Clock | | 485 | 488 | 15,725 | ns |
| twan | Width of Bit Clock High (V _{IH} = 2.2 V) | | 160 | - | - | ns |
| twBL | Width of Bit Clock Low (V _{IL} = 0.6 V) | | 160 | - | - | ns |
| t _{RB} | Rise Time of Bit Clock (t _{PB} = 488 ns) | | _ | - | 50 | пѕ |
| t _{FB} | Fall Time of Bit Clock (tPB = 488 ns) | | - | - | 50 | ns |
| tsbfm | Set-up Time from $BCLK_X$ High to $MCKL_X$ Falli (first bit clock after the leading edge of FS_X) | ng Edge | 100 | _ | - | ns |
| t _{HBF} | Holding Time from Bit Clock Low to the Frame (long frame only) | Sync | 0 | - | - | ns |
| tsfB | Set-up Time from Frame Sync to Bit Clock Lo | w (long frame only) | 80 | | _ | ns |

Note: For short frame sync, timing FSx and FSn must go high while their respective bit clocks are high.



ALL TIMING SPECIFICATIONS (continued)

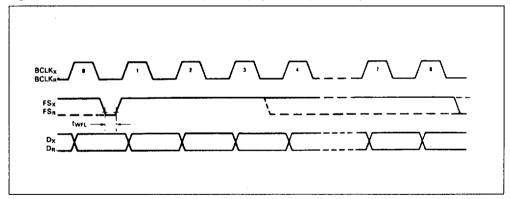
ETC5067-ETC5064

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| Symbol | Parameter | Min. | Тур. | Max. | Unit |
|--------------------|--|------|------|------|------|
| t _{HBFI} | Hold Time from 3rd Period of Bit Clock FS _X or FS _B Low to Frame Sync (long frame only) | 100 | _ | - | ns |
| t _{DZF} | Delay time to valid data from FS_X or $BCLK_X$, whichever comes later and delay time from FS_X to data output disabled. ($C_L = 0$ pF to 150 pF) | - 20 | _ | 165 | ns |
| t _{DBD} | Delay Time from BCLK _X High to Data Valid (Load = 150 pF plus 2 LSTTL loads) | 0 | _ | 150 | ns |
| tozc | Delay Time from BCLK _X Low to Data Output Disabled | 50 | - | 165 | ns |
| t _{SDB} | Set-up Time from D _R Valid to BCLK _{R/X} Low | 50 | _ | _ | ns |
| tHBD | Hold Time from BCLK _{B/X} Low to D _B Invalid | 50 | - | _ | ns |
| tHOLD | Holding Time from Bit Clock High to Frame Sync (short frame only) | 0 | _ | - | ns |
| tsF | Set-up Time from $FS_{X/R}$ to $BCLK_{X/R}$ Low (short frame sync pulse) - Note 1 | 80 | _ | _ | ns |
| t _{HF} | Hold Time from BCLK $_{X/R}$ Low to FS $_{X/R}$ Low (short frame sync pulse) - Note 1 | 100 | | - | ns |
| t _{XDP} | Delay Time TS _X Low (load = 150 pF plus 2 LSTTL loads) | - | - | 140 | ns |
| t _{WFL} · | Minimum Width of the Frame Sync Pulse (low level) (64 k bit/s operating mode) | 160 | - | _ | ns |

Note: 1. For short frame sync. timing FS_x and FS_R must go high while their respective bit clocks are high.

Figure 2:64 k bits/s TIMING DIAGRAM (see next page for complete timing).



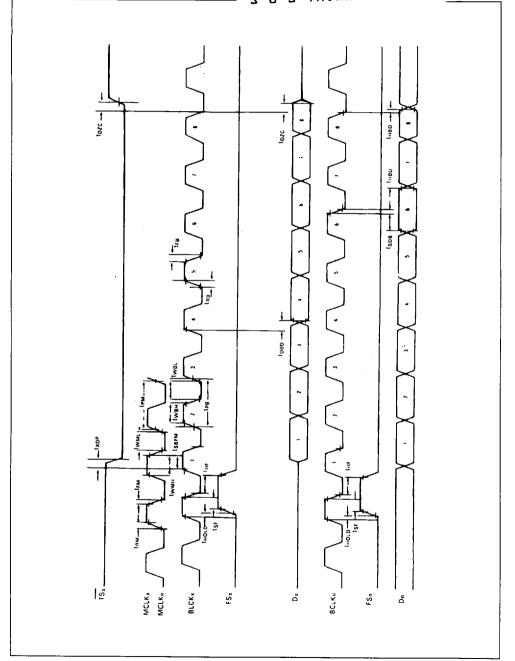
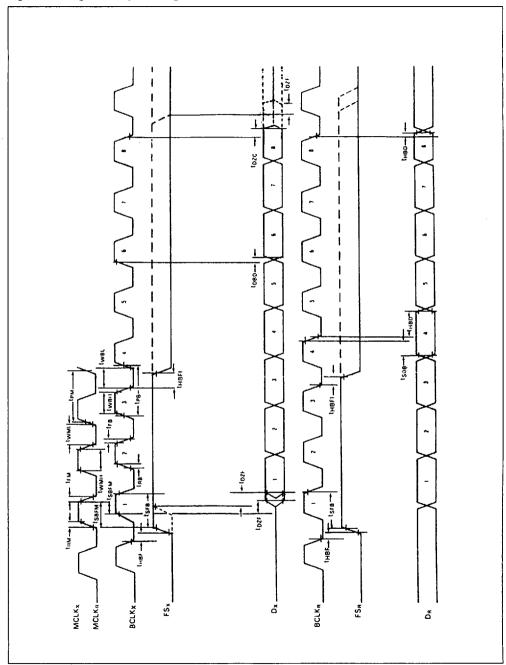


Figure 4: Long Frame Sync Timing.

NOZMOHT-2 Z



TRANSMISSION CHARACTERISTICS

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(all devices) T_A = 0 °C to 70 °C, V_{CC} = 5 V \pm 5 %, V_{BB} = - 5 V \pm 5 %, GNDA = 0 v, f = 1.02 kHz, V_{IN} = 0 dBm0 transmit input amplifier connected for unity-gain non-inverting (unless otherwise specified).

AMPLITUDE RESPONSE

| Symbol | Parameter | Min. | Тур. | Max. | Unit |
|------------------|--|---|---------------------------------|---|-----------------|
| 1 | Absolute Levels – Nominał 0 dBm0 leveł is 4 dBm (600 Ω). 0 dBm0 | _ | 1.2276 | - | V_{rms} |
| tmax | Max Overload Level 3.14 dBm0 ETC5067 3.17 dBm0 ETC5064 | - - | 2.492 2.501 | I - | V _{PK} |
| G _{XA} | Transmit Gain, Absolute ($T_A = 25$ °C, $V_{CC} = 5$ V, $V_{BB} = -5$ V) Input at $GS_X = 0$ dBm0 at 1020 Hz | - 0.15 | _ | 0.15 | dB |
| G _{XR} | Transmit Gain, Relative to G _{XA} f = 16 Hz f = 50 Hz f = 60 Hz f = 180 Hz f = 180 Hz f = 200 Hz f = 300 Hz - 3000 Hz f = 3300 Hz f = 3400 Hz f = 4000 Hz f = 4600 Hz and up, measure response from O Hz to 4000 Hz | - 2.8 - 1.8 - 0.15 - 0.35 - 0.7 | - - - - - - - | - 40 - 30 - 26 - 0.2 - 0.1 0.15 0.05 0 - 14 - 32 | dB |
| GXAT | Absolute Transmit Gain Variation with Temperature $(T_A = 0 \text{ °C to } + 70 \text{ °C})$ | - 0.1 | _ | 0.1 | dB |
| G _{XAV} | Absolute Transmit Gain Variation with Supply Voltage ($V_{CC} = 5 \text{ V} \pm 5 \text{ \%}$, $V_{BB} = -5 \text{ V} \pm 5 \text{ \%}$) | 0.05 | _ | 0.05 | dB |
| G _{XRL} | Transmit Gain Variations with Level Sinusoidal Test Method Reference Level = - 10 dBm0 VF _X I * = - 40 dBm0 to + 3 dBm0 VF _X I * = - 50 dBm0 to - 40 dBm0 VF _X I * = - 55 dBm0 to - 50 dBm0 | - 0.2 - 0.4 - 1.2 | | 0.2 0.4 1.2 | dB |
| GRA | Receive Gain, Absolute ($T_A = 25$ °C, $V_{CC} = 5$ V, $V_{BB} = -5$ V) Input = Digital Code Sequence for 0 dBm0 Signal at 1020 Hz | - 0.15 | - | 0.15 | dB |
| G _{RR} | Receive Gain, Relative to G _{RA} f= 0 Hz to 3000 Hz f = 3300 Hz f = 3400 Hz f = 4000 Hz | 0.15 0.35 0.7 | - - - | 0.15 0.05 0 | dB |
| GRAT | Absolute Receive Gain Variation with Temperature (T _A = 0 °C to + 70 °C) | - 0.1 | _ | 0.1 | dB |
| GRAV | Absolute Receive Gain Variation with Supply Voltage ($V_{CC} = 5 \text{ V} \pm 5 \text{ %}, V_{BB} = -5 \text{ V} \pm 5 \text{ %}$) | - 0.05 | _ | 0.05 | dB |
| G _{RRL} | Receive Gain Variations with Level Sinusoidal Test Method; Reference input PCM code corresponds to an ideally encoded – 10 dBm0 signal PCM level = - 40 dBm0 to + 3 dBm0 PCM level = - 50 dBm0 to - 40 dBm0 PCM level = - 55 dBm0 to - 50 dBm0 | - 0.2 - 0.4 - 1.2 | - - - | 0.2 0.4 1.2 | dB |
| V _{RO} | Receive Filter Output at VF _R O $R_L = 10 \text{ k}\Omega$ | - 2.5 | - | 2.5 | ٧ |

TRANSMISSION CHARACTERISTICS (continued)

NOZMOHT-Z D Z

ENVELOPE DELAY DISTORTION WITH FREQUENCY

| Symbol | Parameter | Min. | Тур. | Max. | Unit |
|-----------------|---|------|------|------|------|
| D _{XA} | Transmit Delay, Absolute (f = 1600 Hz) | - | 290 | 315 | μs |
| D _{XR} | Transmit Delay, Relative to D _{XA} | | | | μs |
| | f = 500 Hz - 600 Hz | - | 195 | 220 | |
| | f = 600 Hz - 800 Hz | _ | 120 | 145 | |
| | f = 800 Hz - 1000 Hz | _ | 50 | 75 | |
| | f = 1000 Hz - 1600 Hz | _ | 20 | 40 | |
| | f = 1600 Hz - 2600 Hz | | 55 | 75 | |
| | f = 2600 Hz - 2800 Hz | - | 80 | 105 | |
| | f = 2800 Hz - 3000 Hz | | 130 | 155 | |
| D _{RA} | Receive Delay, Absolute (f = 1600 Hz) | - | 180 | 200 | μs |
| D _{RR} | Receive Delay, Relative to D _{RA} | | | | μs |
| | f = 500 Hz - 1000 Hz | - 40 | - 25 | _ | |
| | f = 1000 Hz 1600 Hz | - 30 | - 20 | _ | |
| | f = 1600 Hz - 2600 Hz | _ | 70 | 90 | |
| | f = 2600 Hz - 2800 Hz | _ | 100 | 125 | |
| | f = 2800 Hz - 3000 Hz | - | 145 | 175 | |

NOISE

| Symbol | Parameter | Min. | Тур. | Max. | Unit |
|-------------------|---|------|-------------------|------------------|-----------------|
| N _{XP} | Transmit Noise, P Message Weighted (ETC5067, VF _X I * = 0 V) | | - 74 | - 69 (note 1) | dBm0p |
| N _{RP} | Receive Noise, P Message Weighted (ETC5067, PCM Code Equals Positive Zero) | | - 82 | - 79 | dBm0p |
| N _{XC} | Transmit Noise, C Message Weighted (ETC5064, VFXI + = 0 V) | _ | 12 | 15 | dBrnC0 |
| N _{RC} | Receive Noise, C Message Weighted (ETC5064, PCM Code Equals Alternating Positive and Negative Zero) | | 8 | 11 | dBrnC0 |
| N _{RS} | Noise, Single Frequency f = 0 kHz to 100 kHz, Loop Around Measurement, VF _X I * = 0 Vrms | | _ | - 53 | dBm0 |
| PPSR _X | Positive Power Supply Rejection, Transmit VF _x I ⁺ = 0 Vrms, V _{CC} = -5.0 V _{DC} + 100 mVrms, f = 0 kHz - 50 kHz | | - | - | dBp |
| NPSRx | Negative Power Supply Rejection, Transmit VF _X I * = 0 Vrms, V _{BB} = - 5.0 V _{DC} + 100 mVrms, f = 0 kHz - 50 kHz | | - | - | dBp |
| PPSR _B | Positive Power Supply Rejection, Receive (PCM code equals positive zero, V _{CC} = 5.0 V _{DC} + 100 mVrms) f = 0 Hz - 4000 Hz f = 4 kHz - 25 kHz f = 25 kHz - 50 KHZ | | - - | | dBp dB dB |
| NPSR _R | Negative Power Supply Rejection, Receive (PCM code equals positive zero, V _{BB} = - 5.0 V _{DC} + 100 mVrms) f = 0 Hz - 4000 Hz f = 4 kHz - 25 kHz f = 25 kHz - 50 kHz | | - - | - - - | dBp dB dB |

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TRANSMISSION CHARACTERISTICS (continued)

| Symbol | Parameter | Min. | Тур. | Max. | Unit |
|--------|--|------|----------|--------------|------|
| SOS | Spurious out-of band signals at the channel output. Loop around measurement, 0 dBm0, 300 Hz – 3400 Hz input applied to VF _x I *, measure individual image signals at VF _R 0 | | | | dB |
| | 4600 Hz – 7600 Hz | - | _ | - 32 | |
| | 7600 Hz – 8400 Hz 8400 Hz – 100,000 Hz | - | - - | - 40 - 32 | |

DISTORTION

| Symbol | Parameter | | Min. | Тур. | Max. | Unit |
|------------------------|---|-----|------|------|------|------|
| STD _x or | Signal to Total Distortion (sinusoidal test method) | | | | | dBp |
| STDR | Transmit or Receive Half-channel | | | | | |
| | Level = 3 dBm0 | | 33 | - | - | |
| | = 0 dBm0 to - 30 dBm0 | | 36 | - | - | |
| | = - 40 dBm0 | XMT | 29 | - | - | |
| | | RCV | 30 | - | i – | |
| | = - 55 dBm0 | XMT | 14 | - | - | |
| | | RCV | 15 | | _ | |
| SFD _X | Single Frequency Distortion, Transmit | | _ | | - 46 | dB |
| SFDR | Single Frequency Distortion, Receive | | _ | - | - 46 | dB |
| IMD | Intermodulation Distortion Loop Around Measurement, VF _X I + = - 4 dBm0 to - 21 dBm0, Two Frequencies in the Range 300 Hz - 3400 Hz | | - | | - 41 | dB |

CROSSTALK

| Symbol | Parameter | Min. | Тур. | Max. | Unit |
|-------------------|---|------|------|------------------|------|
| CT _{X-R} | Transmit to Receive Crosstalk, 0 dBm0 Transmit Level f = 300 Hz - 3400 Hz, D _B = Steady PCM Mode | _ | - 90 | – 75 | dB |
| CT _{R-X} | Receive to Transmit Crosstalk, 0 dBm0 Receive Level f = 300 Hz - 3400 Hz, VF _X I = 0 V | - | - 90 | - 70 (note 2) | dB |

POWER AMPLIFIERS

| Symbol | Parameter | Min. | Тур. | Max. | Unit |
|-----------------|--|-------------------|-------------|-------------|------|
| V _{OL} | Maximum 0 dBm0 level for better than \pm 0.1 dB linearity over the range 10 dBm0 to + 3 dBm0 (balanced load, R _L connected between VPO $^+$ and VPO $^-$). R _L = 600 Ω R _L = 1200 Ω R _L = 30 k Ω | 3.3 3.5 4.0 | - - - | - - - | Vrms |
| S/Dp | Signal/Distortion $R_L = 600 \Omega$, 0 dBm0 | 50 | | - | dB |

Notes: 1. Measured by extrapolation from the distortion test result.

^{2.} CT_{R-X} is measured with a – 40 dBm0 activating signal applied at VF_XI*.

ETC5067-ETC5064

ENCODING FORMAT AT Dy OUTPUT

MOZMOHT-Z & Z

| | A-Law (including even bit inversion) | μ Law |
|--|---|-----------------------|
| V _{IN} (at GS _X) = + Full-scale | 10101010 | 1000000 |
| V_{IN} (at GS_X) = 0 V | { 1 1 0 1 0 1 0 1 0 1 0 1 0 1 0 1 0 1 0 | {11111111 {0111111 |
| V _{IN} (at GS _X) = - Full-scale | 00101010 | 0000000 |

APPLICATIONS INFORMATION

POWER SUPPLIES

While the pins of the ETC5060 family are well protected against electrical misuse, it is recommended that the standard CMOS practice be followed, ensuring that ground is connected to the device before any other connections are made. In applications where the printed circuit board may be plugged into a "hot" socket with power and clocks already present, an extra long ground pin in the connector should be used.

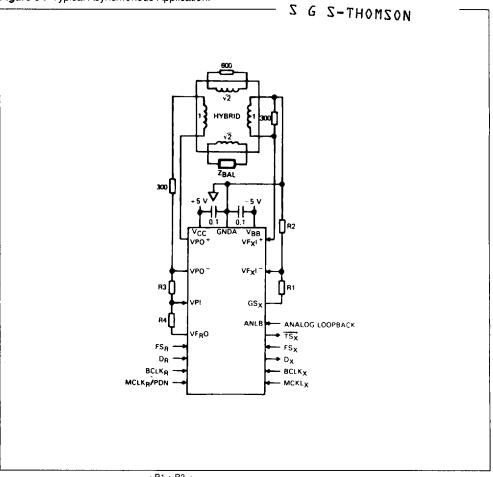
All ground connections to each device should meet at a common point as close as possible to the GNDA

pin. This minimizes the interaction of ground return currents flowing through a common bus impedance. 0.1 µF supply decoupling capacitors should be connected from this common ground point to Vcc and V_{BB} as close to the device as possible.

For best performance, the ground point of each CODEC/FILTER on a card should be connected to a common card ground in star formation, rather than via a ground bus. This common ground point should be decoupled to Vcc and VBB with 10 µF capacitors.

For best performance either, TS x should be arounded if not used.

Figure 5: Typical Asynchronous Application.



Notes: 1. Transmit Gain =
$$20 \times log \left(\frac{R1 + R2}{R2}\right) \cdot (R1 + R2) \ge 10 \text{ k}\Omega$$

2. Receive gain = $20 \times log \left(\frac{2 \times R3}{R4}\right) \cdot R4 \le 10 \text{ k}\Omega$.

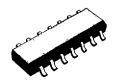
T-90-20

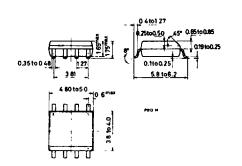
SO-14J

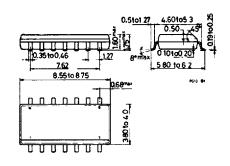
SO-8J

S G S-THOMSON







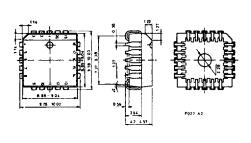


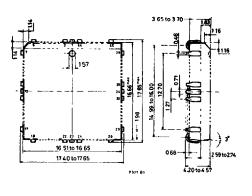
PLCC20

PLCC44





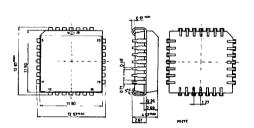




NOZMOHT-Z D Z

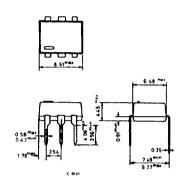
PLCC-28 Plastic Chip Carrier



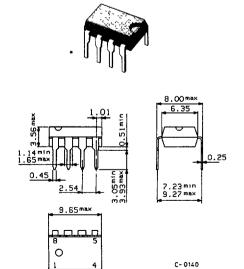


DIP-6



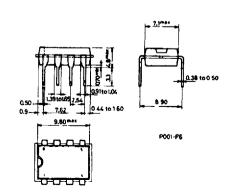


Minidip A Plastic



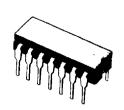
8 lead Plastic Minidip

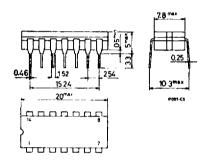




S G Z-THOMSON

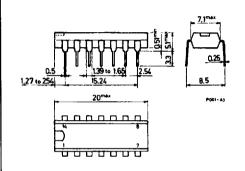
14 lead Ceramic Dip





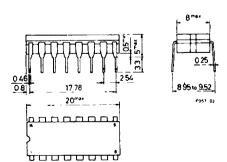
14 lead Plastic D.p



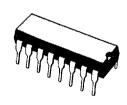


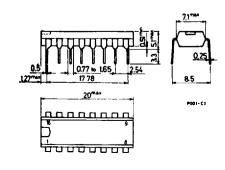
16 lead Ceramic Dip



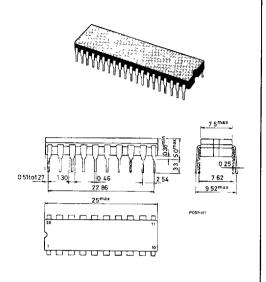


16 lead Plastic Dip (0.25)

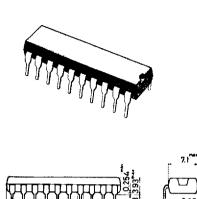


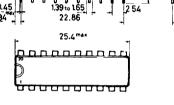


DIP-20 Ceramic

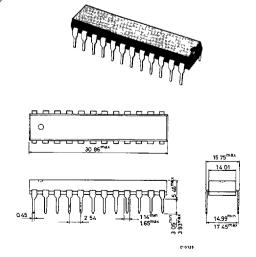


20 lead Plastic Dip (0.25)

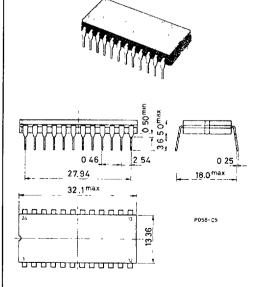




DIP-24 Plastic

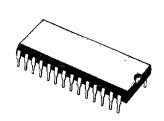


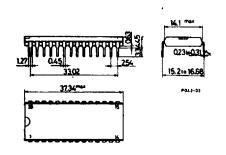
DIP-24 Ceramic (0.25)



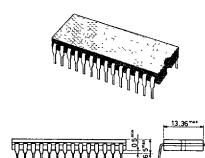
NOZMOHT-Z D Z

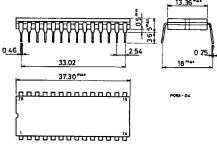
28 lead Plastic Dip



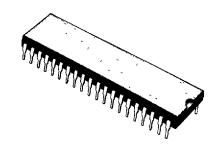


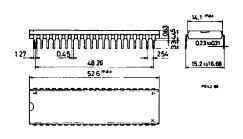
DIP-28 Ceramic (0.25)



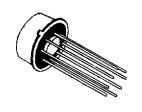


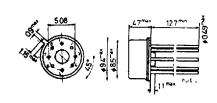
40 lead Plastic Dip





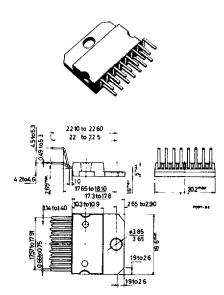
TO-99





S G S-THOMSON

MULTIWATT-15



FLEXIWATT-15

